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# FCP150N65F

## N-Channel SuperFET® II FRFET® MOSFET

650 V, 24 A, 150 mΩ

### Features

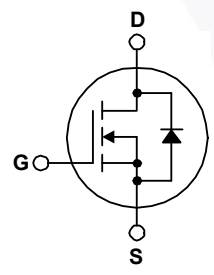
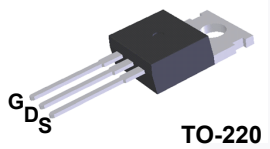
- 700 V @  $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 133\text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 72\text{ nC}$ )
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 361\text{ pF}$ )
- 100% Avalanche Tested
- RoHS Compliant

### Applications

- LCD / LED / PDP TV
- Telecom / Server Power Supplies
- Solar Inverter
- AC - DC Power Supply

### Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance,  $dv/dt$  rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SuperFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol         | Parameter  | FCP150N65F                                 | Unit             |
|----------------|--|--|------------------|
| $V_{DSS}$      | Drain to Source Voltage  | 650  | V                |
| $V_{GSS}$      | Gate to Source Voltage   | - DC                                       | $\pm 20$         |
|                |  | - AC ( $f > 1\text{ Hz}$ )                 | $\pm 30$         |
| $I_D$          | Drain Current  | - Continuous ( $T_C = 25^\circ\text{C}$ )  | 24               |
|                |  | - Continuous ( $T_C = 100^\circ\text{C}$ ) | 14.9             |
| $I_{DM}$       | Drain Current - Pulsed (Note 1)                                      | 72   | A                |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                              | 663  | mJ               |
| $I_{AR}$       | Avalanche Current (Note 1)   | 4.7  | A                |
| $E_{AR}$       | Repetitive Avalanche Energy (Note 1)                                 | 2.98                                       | mJ               |
| $dv/dt$        | MOSFET $dv/dt$   | 100  | V/ns             |
|                | Peak Diode Recovery $dv/dt$ (Note 3)                                 | 50   |                  |
| $P_D$          | Power Dissipation ( $T_C = 25^\circ\text{C}$ )                       |  | 298              |
|                |  | - Derate Above $25^\circ\text{C}$          | 2.38             |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                              | -55 to +150                                | $^\circ\text{C}$ |
| $T_L$          | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | 300  | $^\circ\text{C}$ |

### Thermal Characteristics

| Symbol          | Parameter                                     | FCP150N65F | Unit               |
|-----------------|---|------------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.42       | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5       |                    |

## Package Marking and Ordering Information

| Part Number | Top Mark   | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|------------|---------|----------------|-----------|------------|----------|
| FCP150N65F  | FCP150N65F | TO-220  | Tube           | N/A       | N/A        | 50 units |

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

### Off Characteristics

|                                |   |   |     |      |           |                    |
|--------------------------------|---|---|-----|------|-----------|--------------------|
| $BV_{DSS}$                     | Drain to Source Breakdown Voltage         | $V_{GS} = 0\text{ V}, I_D = 10\text{ mA}, T_J = 25^\circ\text{C}$     | 650 | -    | -         | V                  |
|                                |   | $V_{GS} = 0\text{ V}, I_D = 10\text{ mA}, T_J = 150^\circ\text{C}$    | 700 | -    | -         |                    |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 10\text{ mA}$ , Referenced to $25^\circ\text{C}$               | -   | 0.72 | -         | $V/^\circ\text{C}$ |
| $I_{DSS}$                      | Zero Gate Voltage Drain Current           | $V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V}$                          | -   | -    | 10        | $\mu\text{A}$      |
|                                |   | $V_{DS} = 520\text{ V}, V_{GS} = 0\text{ V}, T_C = 125^\circ\text{C}$ | -   | 86   | -         |                    |
| $I_{GSS}$                      | Gate to Body Leakage Current              | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$                       | -   | -    | $\pm 100$ | nA                 |

### On Characteristics

|              |                                      |   |   |     |     |                  |
|--------------|--------------------------------------|---|---|-----|-----|------------------|
| $V_{GS(th)}$ | Gate Threshold Voltage               | $V_{GS} = V_{DS}, I_D = 2.4\text{ mA}$    | 3 | -   | 5   | V                |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10\text{ V}, I_D = 12\text{ A}$ | - | 133 | 150 | $\text{m}\Omega$ |
| $g_{FS}$     | Forward Transconductance             | $V_{DS} = 20\text{ V}, I_D = 12\text{ A}$ | - | 22  | -   | S                |

### Dynamic Characteristics

|                       |                               |  |          |      |      |          |
|-----------------------|-------------------------------|--|----------|------|------|----------|
| $C_{iss}$             | Input Capacitance             | $V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$   | -        | 2810 | 3737 | pF       |
| $C_{oss}$             | Output Capacitance            |  | -        | 91   | 121  | pF       |
| $C_{riss}$            | Reverse Transfer Capacitance  |  | -        | 0.77 | -    | pF       |
| $C_{oss}$             | Output Capacitance            | $V_{DS} = 380\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$   | -        | 54   | -    | pF       |
| $C_{oss\text{ eff.}}$ | Effective Output Capacitance  | $V_{DS} = 0\text{ V to } 400\text{ V}, V_{GS} = 0\text{ V}$      | -        | 361  | -    | pF       |
| $Q_{g(tot)}$          | Total Gate Charge at 10V      | $V_{DS} = 380\text{ V}, I_D = 12\text{ A}, V_{GS} = 10\text{ V}$ | -        | 72   | 94   | nC       |
| $Q_{gs}$              | Gate to Source Gate Charge    |  | -        | 15   | -    | nC       |
| $Q_{gd}$              | Gate to Drain "Miller" Charge |  | (Note 4) | -    | 31   | -        |
| ESR                   | Equivalent Series Resistance  | $f = 1\text{ MHz}$   | -        | 0.69 | -    | $\Omega$ |

### Switching Characteristics

|              |                     |   |          |    |    |     |    |
|--------------|---------------------|---|----------|----|----|-----|----|
| $t_{d(on)}$  | Turn-On Delay Time  | $V_{DD} = 380\text{ V}, I_D = 12\text{ A}, V_{GS} = 10\text{ V}, R_g = 4.7\text{ }\Omega$ | -        | 28 | 66 | ns  |    |
| $t_r$        | Turn-On Rise Time   |   | -        | 15 | 40 | ns  |    |
| $t_{d(off)}$ | Turn-Off Delay Time |   | (Note 4) | -  | 73 | 156 | ns |
| $t_f$        | Turn-Off Fall Time  |   | (Note 4) | -  | 6  | 22  | ns |

### Drain-Source Diode Characteristics

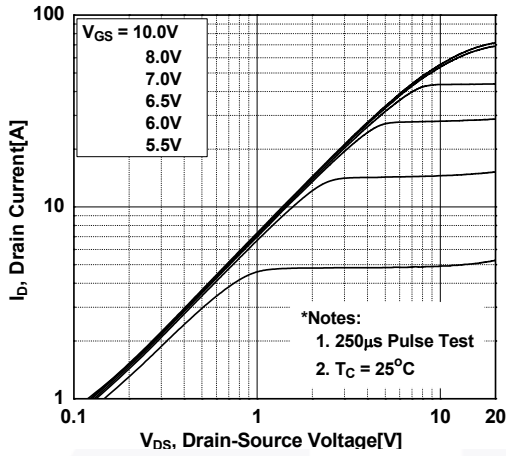
|          |  |   |   |     |     |    |
|----------|--|---|---|-----|-----|----|
| $I_S$    | Maximum Continuous Drain to Source Diode Forward Current | -   | - | 24  | A   |    |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current     | -   | - | 72  | A   |    |
| $V_{SD}$ | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0\text{ V}, I_{SD} = 12\text{ A}$ | - | -   | 1.2 | V  |
| $t_{rr}$ | Reverse Recovery Time                                    | $V_{GS} = 0\text{ V}, I_{SD} = 12\text{ A}$ | - | 123 | -   | ns |
| $Q_{rr}$ | Reverse Recovery Charge                                  | $di_F/dt = 100\text{ A}/\mu\text{s}$        | - | 597 | -   | nC |

#### Notes:

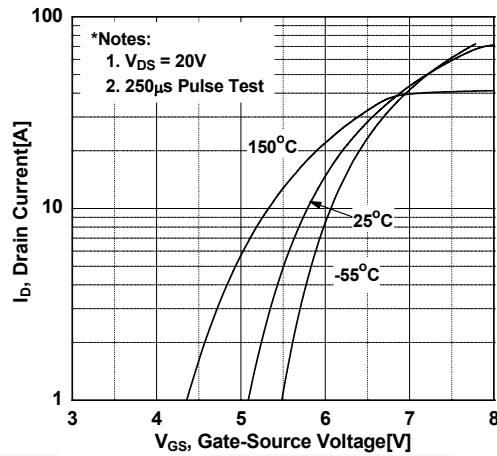
1. Repetitive rating: pulse width limited by maximum junction temperature.
2.  $I_{AS} = 4.7\text{ A}, R_G = 25\text{ }\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 12\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq 380\text{ V}$ , Starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature.

## Typical Performance Characteristics

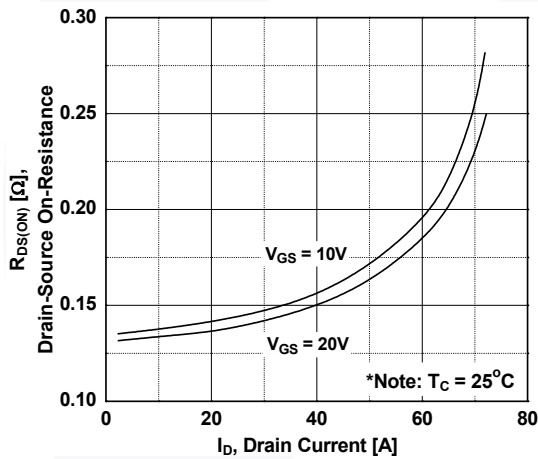
**Figure 1. On-Region Characteristics**



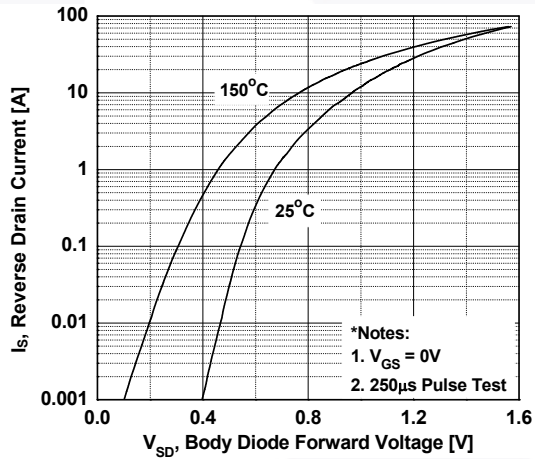
**Figure 2. Transfer Characteristics**



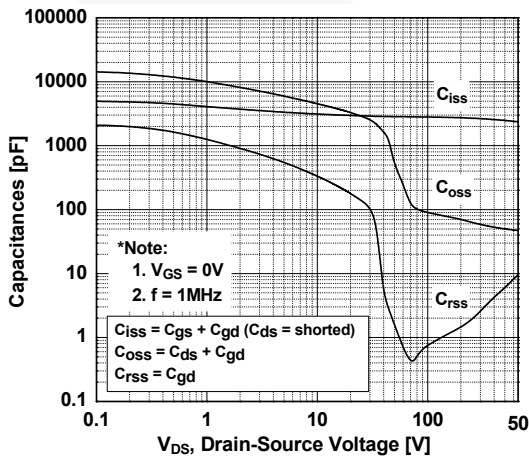
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



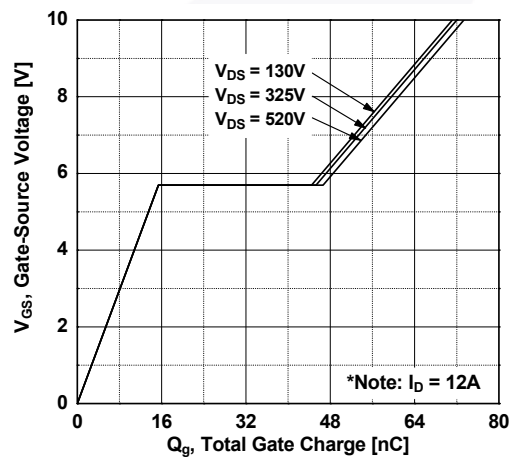
**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 5. Capacitance Characteristics**



**Figure 6. Gate Charge Characteristics**



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

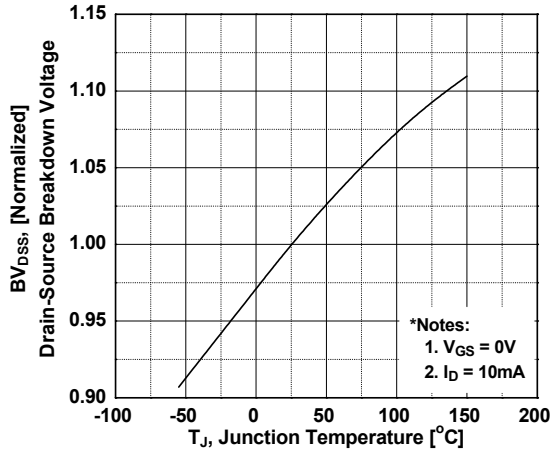


Figure 8. On-Resistance Variation vs. Temperature

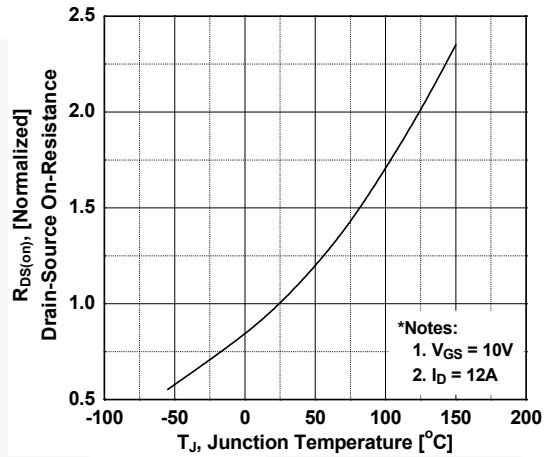


Figure 9. Maximum Safe Operating Area

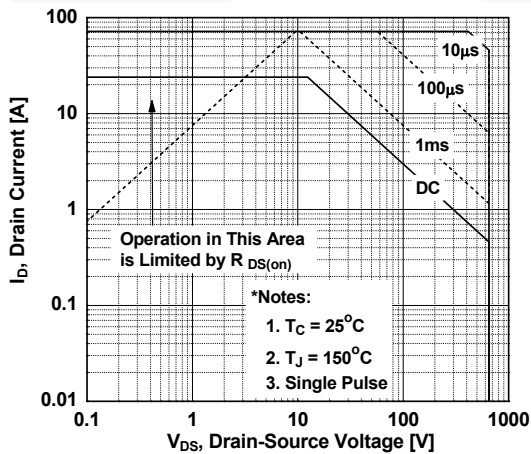


Figure 10. Maximum Drain Current vs. Case Temperature

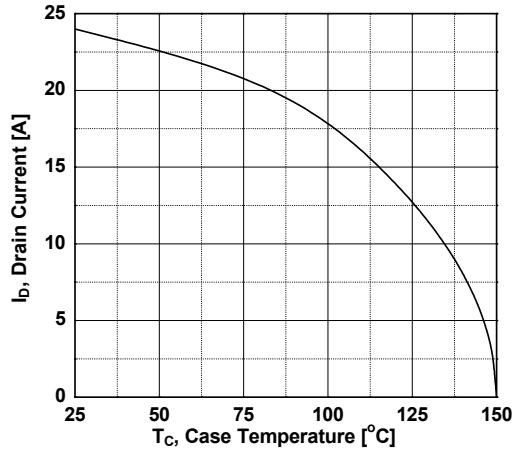
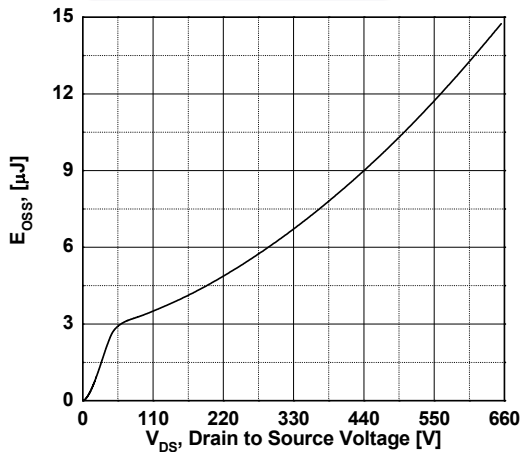
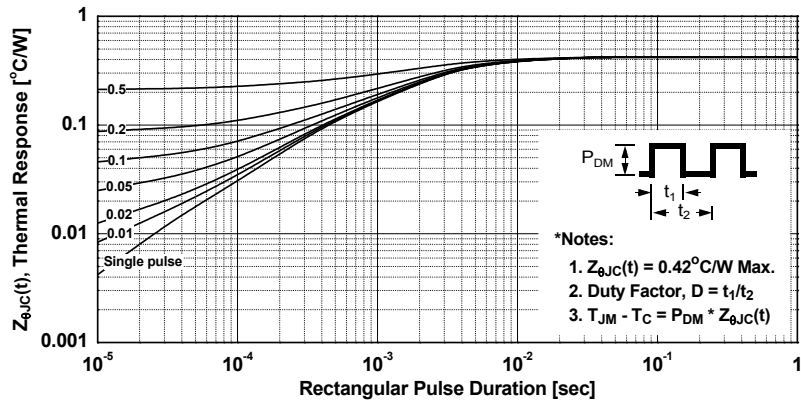


Figure 11. E\_oss vs. Drain to Source Voltage



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



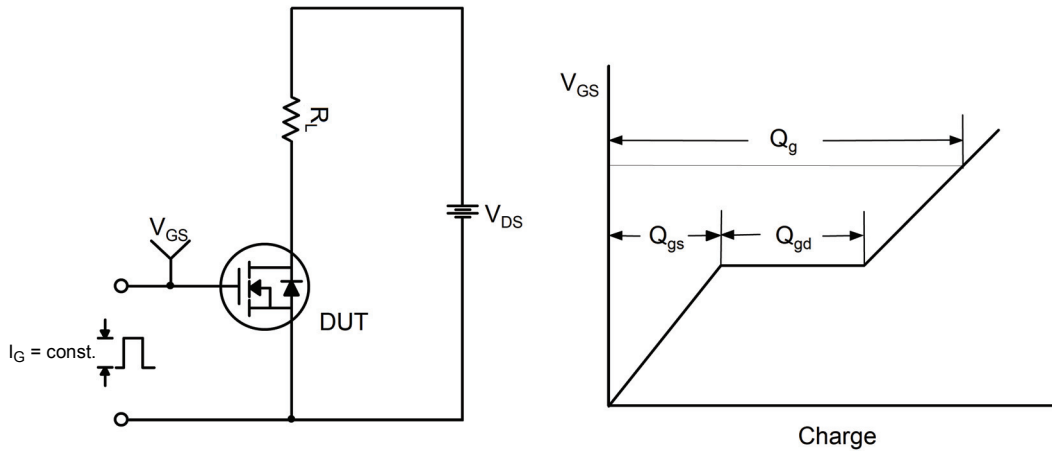


Figure 13. Gate Charge Test Circuit & Waveform



Figure 14. Resistive Switching Test Circuit & Waveforms



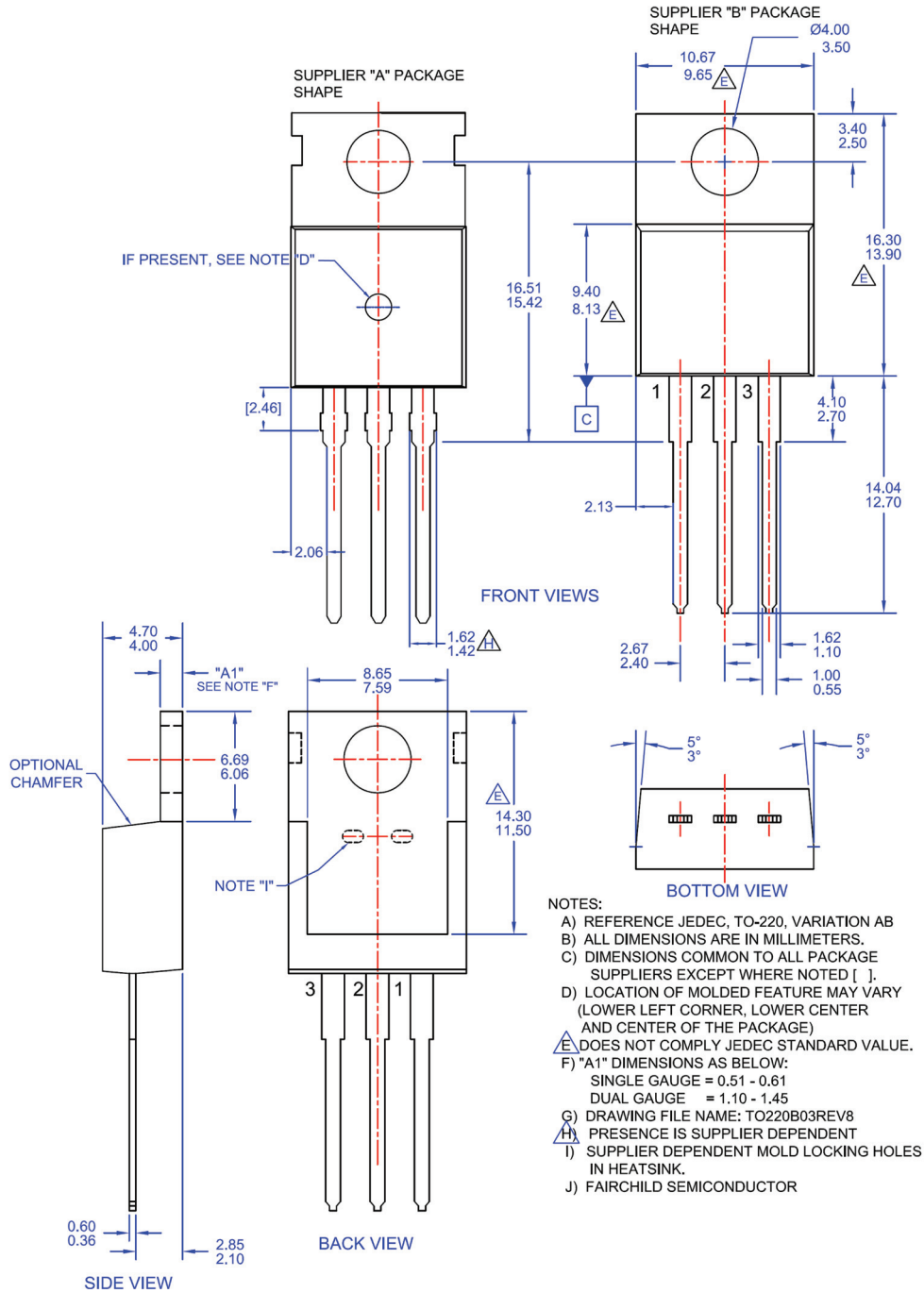
Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 16. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms



## Mechanical Dimensions



**Figure 17. TO-220, Molded, 3-Lead, Jedec Variation AB**

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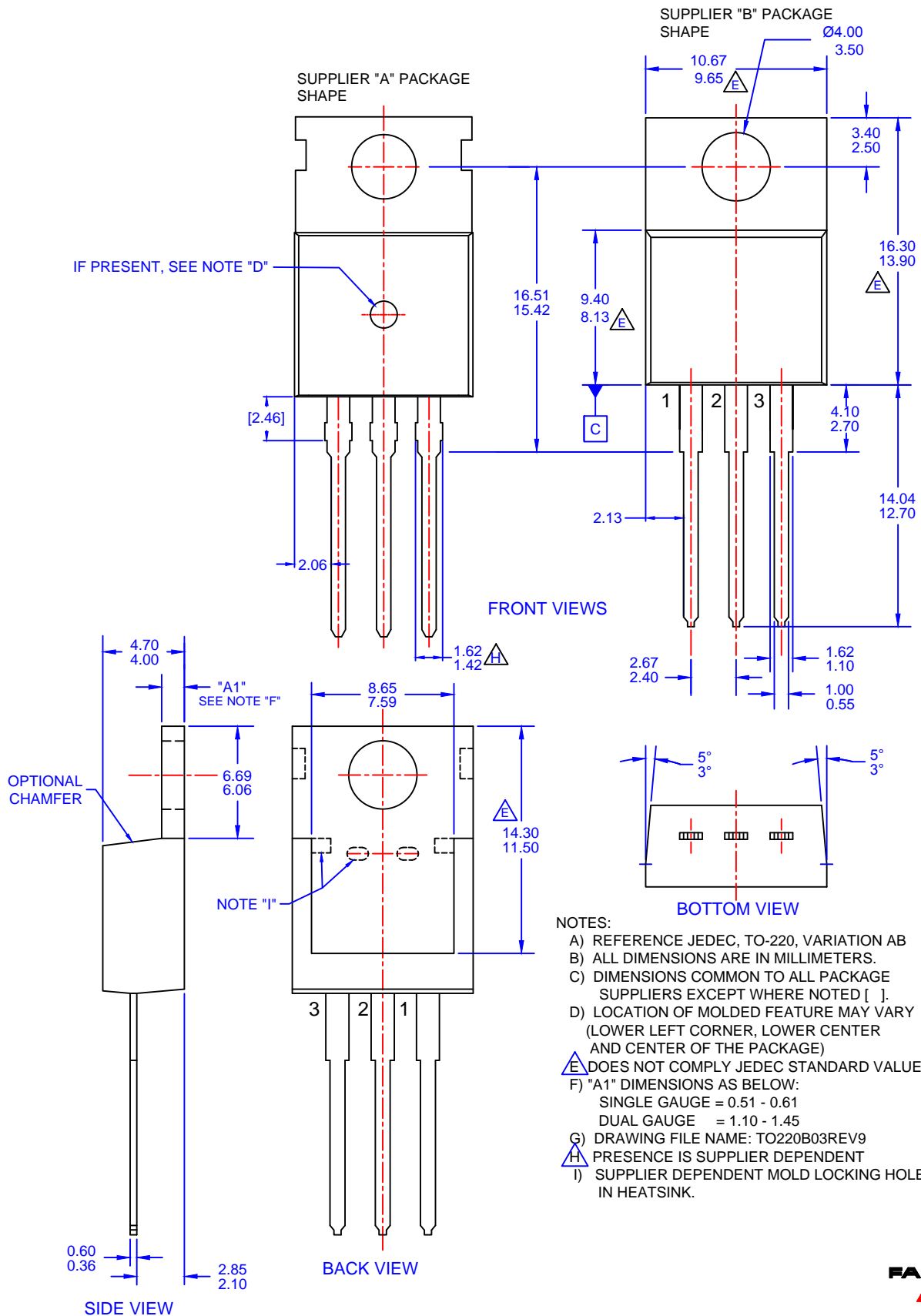
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